

POWER AMPLIFIER MODULE ASSEMBLY

ABSTRACT OF THE DISCLOSURE

A power amplifier module assembly (100) includes a PA module (102) having
5 a flange (104) and a mounting bracket (106) coupled thereto. A thermally conductive
pad (108) having an electrically conductive surface (110) that couples to the mounting
bracket (106) and the flange (104) via a chassis (204) so as to provide both shielding
and thermal dissipation to the PA module (102).

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